

Atty. Docket No. AMAT/4582/ISM/COPPER/D

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Box Patent Application

Assistant Commissioner of Patents and Trademarks Washington, D.C. 20231

Re: Inventor(s): PETER HEY and BYUNG-SUNG LEO KWAK

Title:

METHOD AND APPARATUS TO OVERCOME ANOMALIES IN COPPER SEED

LAYERS AND TO TUNE FOR FEATURE SIZE AND ASPECT RATIO

Transmitted herewith is the patent application identified above, including:

- X Specification, claims and abstract, totaling 21 pages.
- X Drawings totaling 3 pages, X Formal Informal.
- X Executed Declaration and Power of Attorney.
- Information Disclosure Statement w/ Form 1449 and References.
- X Assignment of the invention to Applied Materials, Inc.

Assignment Recordation Cover Sheet

FEE CALCULATION Claims Included With Extra Fee Items Filed Basic Fee Claims Fee Rate Total Total Claims 21 -20 =x \$\$9.00 \$ 18.00 Independent Claims 3 -3-0 x \$80.00 \$ 0.00 Basic Filing Fee \$710.00 \$710.00 TOTAL FEES \$728.00

- The Commissioner is hereby authorized to charge \$728.00 to Deposit Account No. 50-X 1074/4582/ISM/COPPER/DV.
- <u>X</u> . The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment to Deposit Account No. 50-1074/4582/ISM/COPPER/DV. A duplicate copy of this transmittal is enclosed.
- Х Please address all future correspondence to:

PATENT COUNSEL

APPLIED MATERIALS, INC.

Legal Affairs Department

P.O.BOX 450A Santa Clara, CA, 95052

I hereby certify that this correspondence is being deposited with the United States Postal Service as express mail in an envelope addressed to: Commissioner of Patents and Trademarks, Washington, D.C. 20231.

Express Mail Receipt No <u>EL684621630US</u>

Date of Deposit 5-10-01

Robert W. Mulcahy Registration No. 25,436

Respectfully submitted

(713) 623-4844

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